

**HEXFRED
ULTRAFAST, SOFT RECOVERY DIODE**

| |
|------------------|
| $V_R = 1200V$ |
| $V_F = 3.0V$ |
| $Q_{RR} = 675nC$ |

Features

- Reduced RFI and EMI
- Reduced Snubbing
- Extensive Characterization of Recovery Parameters
- Hermetically Sealed
- Ceramic Eyelets

Description


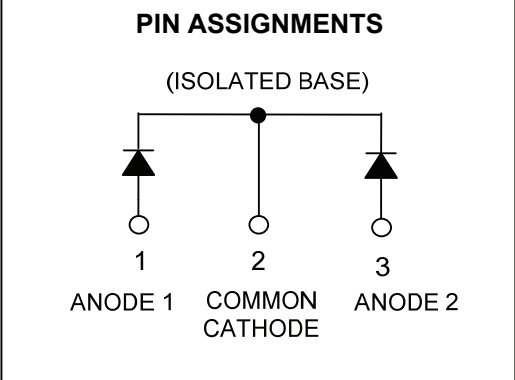
HFA45HI120C is part of the International Rectifier HiRel family of products. These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and di/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

Absolute Maximum Ratings

| Characteristics | Characteristics | Max. | Units |
|--------------------------|--|------------|------------|
| V_R | Cathode to Anode Voltage (Per Leg) | 1200 | V |
| $I_{F(AV)}$ | Continuous Forward Current, $T_C = 100^\circ C$ (Per Leg) ① | 14 | A |
| I_{FSM} | Single Pulse Forward Current, $T_C = 25^\circ C$ (Per Leg) ② | 190 | A |
| $P_D @ T_C = 25^\circ C$ | Maximum Power Dissipation | 104 | W |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | -55 to 150 | $^\circ C$ |

Notes:

- ① D.C. = 50% rectangle wave
- ② 1/2 sine wave, 60Hz, Pulse Width = 8.33ms

| | |
|---|---|
| <p>CASE STYLE</p>  <p>TO-259AA</p> | <p>PIN ASSIGNMENTS</p> <p>(ISOLATED BASE)</p>  <p>1 ANODE 1 2 COMMON CATHODE 3 ANODE 2</p> |
|---|---|

Electrical Characteristics (Per Leg) @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Test Conditions |
|----------|---|------|------|------|---------------|--|
| V_{BR} | Cathode Anode Breakdown Voltage | 1200 | — | | V | $I_R = 100\mu\text{A}$ |
| V_{FM} | Max Forward Voltage See Fig. 1 | — | — | 3.5 | V | $I_F = 14\text{A}, T_J = -55^\circ\text{C}$ |
| | | — | — | 3.0 | | $I_F = 14\text{A}$ |
| | | — | — | 3.9 | | $I_F = 28\text{A}$ |
| | | — | — | 2.7 | | $I_F = 14\text{A}, T_J = 125^\circ\text{C}$ |
| I_{RM} | Max Reverse Leakage Current See Fig. 2 | — | — | 10 | μA | $V_R = V_R \text{ Rated}$ |
| | | — | — | 1.0 | mA | $V_R = V_R \text{ Rated}, T_J = 125^\circ\text{C}$ |
| C_T | Junction Capacitance, See Fig. 3 | — | — | 40 | pF | $V_R = 200\text{V}$ |
| L_S | Series Inductance | — | 13 | — | nH | Measured from Anode lead to Cathode lead, 6mm (0.25 in) from package |

Dynamic Recovery Characteristics (Per Leg) @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Test Conditions | |
|-------------------|---------------------------------------|------|------|------|------------------------|---------------------------|-------------------------------------|
| t_{rr1} | Reverse Recovery Time | — | 80 | 135 | ns | $T_J = 25^\circ\text{C}$ | $I_F = 14\text{A}$ |
| t_{rr2} | See Fig. 5 | — | 120 | — | | $T_J = 125^\circ\text{C}$ | |
| I_{RRM1} | Peak Recovery Current | — | 6.0 | 10 | A | $T_J = 25^\circ\text{C}$ | $V_R = 200\text{V}$ |
| I_{RRM2} | See Fig. 6 | — | 9.0 | — | | $T_J = 125^\circ\text{C}$ | |
| Q_{rr1} | Reverse Recovery Charge | — | 400 | 675 | nC | $T_J = 25^\circ\text{C}$ | $di_f/dt = 200\text{A}/\mu\text{s}$ |
| Q_{rr2} | See Fig. 7 | — | 800 | — | | $T_J = 125^\circ\text{C}$ | |
| $di_{(rec)M}/dt1$ | Peak Rate of Fall of Recovery Current | — | 190 | — | $\text{A}/\mu\text{s}$ | $T_J = 25^\circ\text{C}$ | |
| $di_{(rec)M}/dt1$ | During t_b - See Fig. 8 | — | 170 | — | | $T_J = 125^\circ\text{C}$ | |

Thermal - Mechanical Characteristics

| | Parameter | Typ. | Max. | Units |
|-----------------|---|------|------|---------------------------|
| $R_{\theta JC}$ | Junction-to-Case, Single Leg Conducting. See Fig. 4 | — | 1.2 | $^\circ\text{C}/\text{W}$ |
| Wt | Weight | 10.9 | — | g |

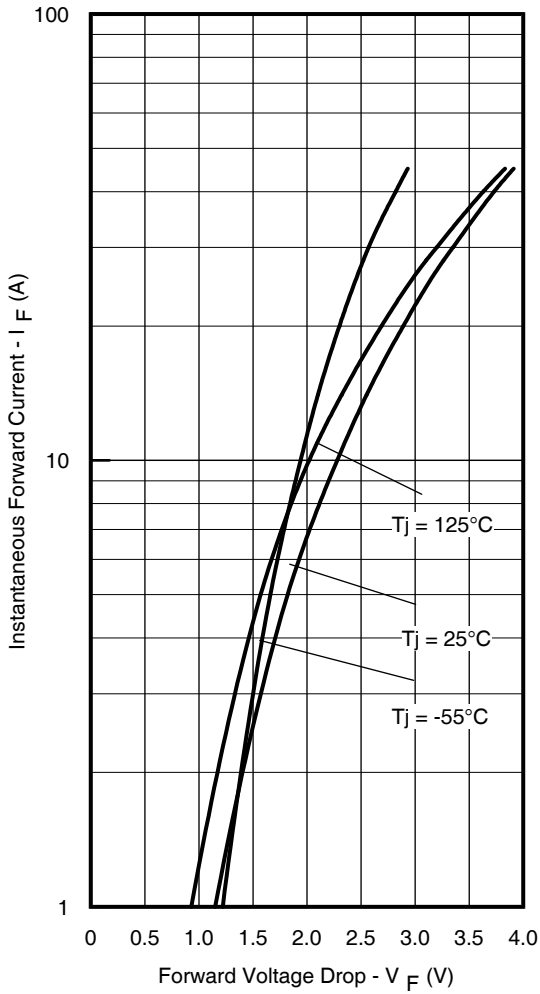


Fig. 1 Typical Forward Voltage Drop Characteristics (Per Leg)

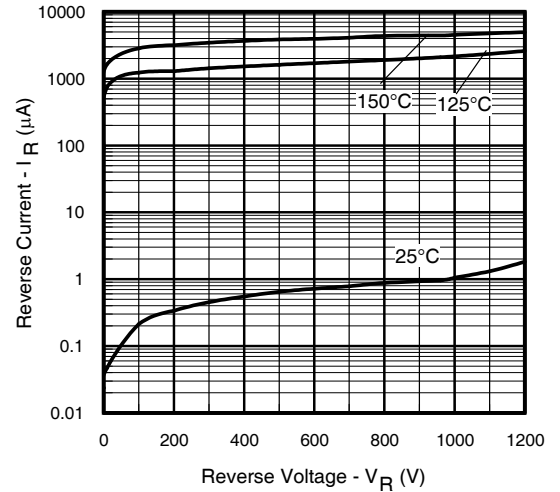


Fig. 2 Typical Values of Reverse Current Vs. Reverse Voltage (Per Leg)

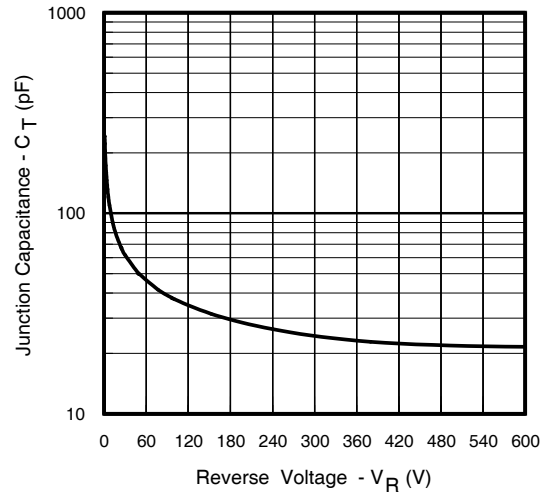


Fig. 3 Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

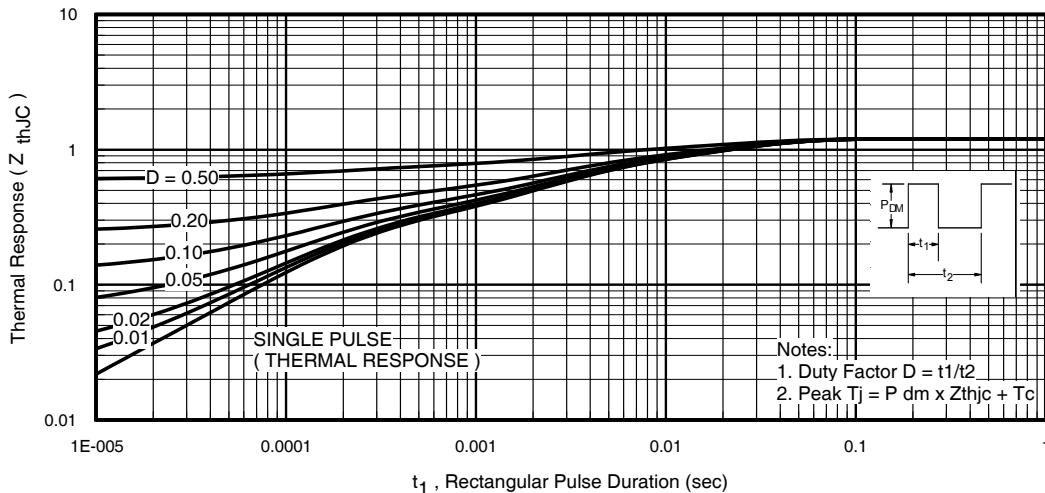


Fig. 4 Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

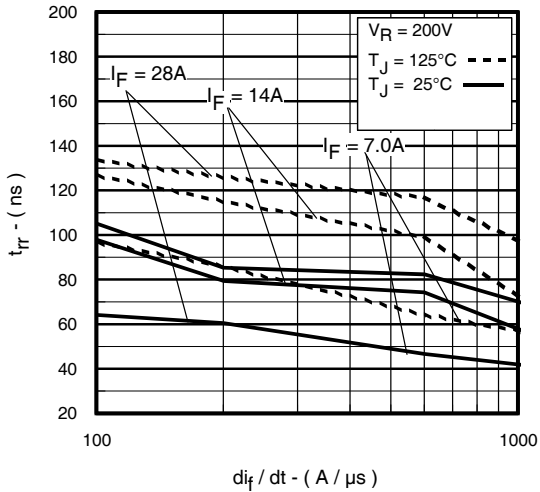


Fig. 5 Typical Reverse Recovery Vs di_f/dt (Per Leg)

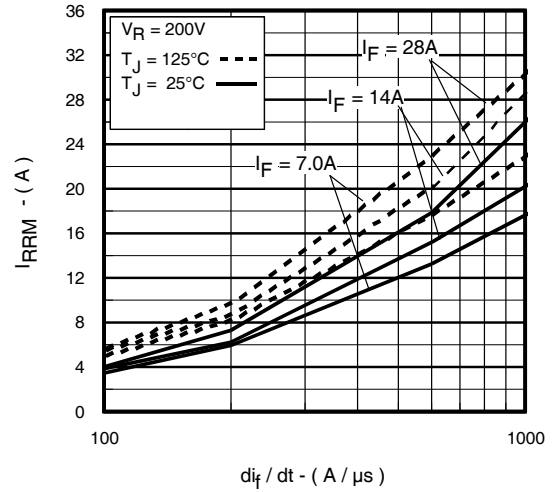


Fig. 6 Typical Recovery Current Vs di_f/dt (Per Leg)

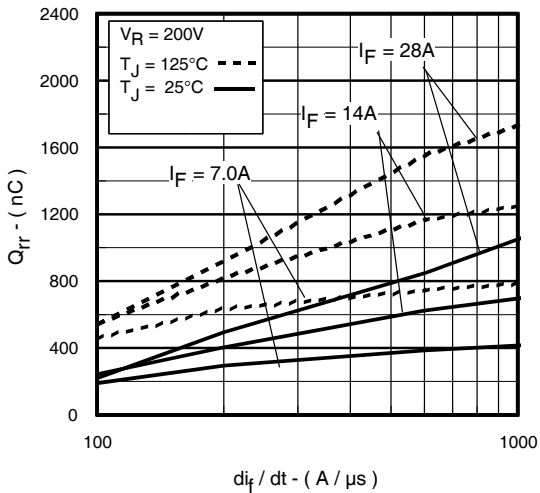


Fig. 7 Typical Stored Charge Vs di_f/dt (Per Leg)

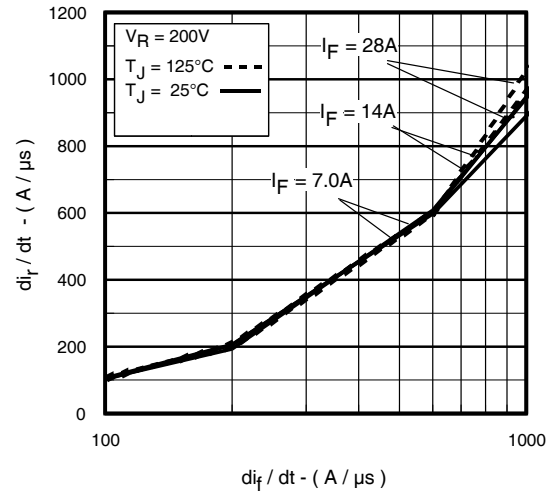


Fig. 8 Typical $di_{(rec)M}/dt$ Vs di_f/dt (Per Leg)

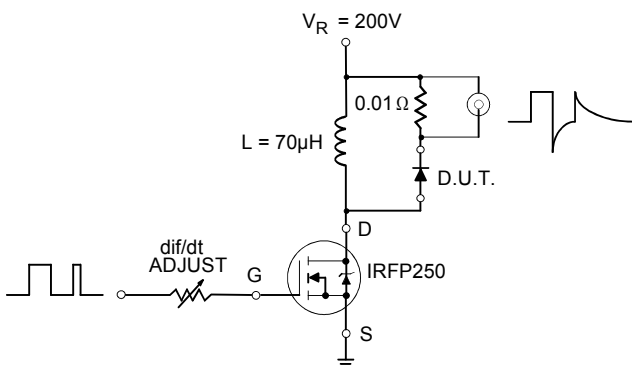
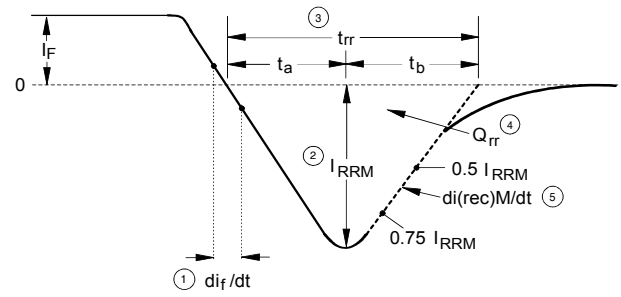


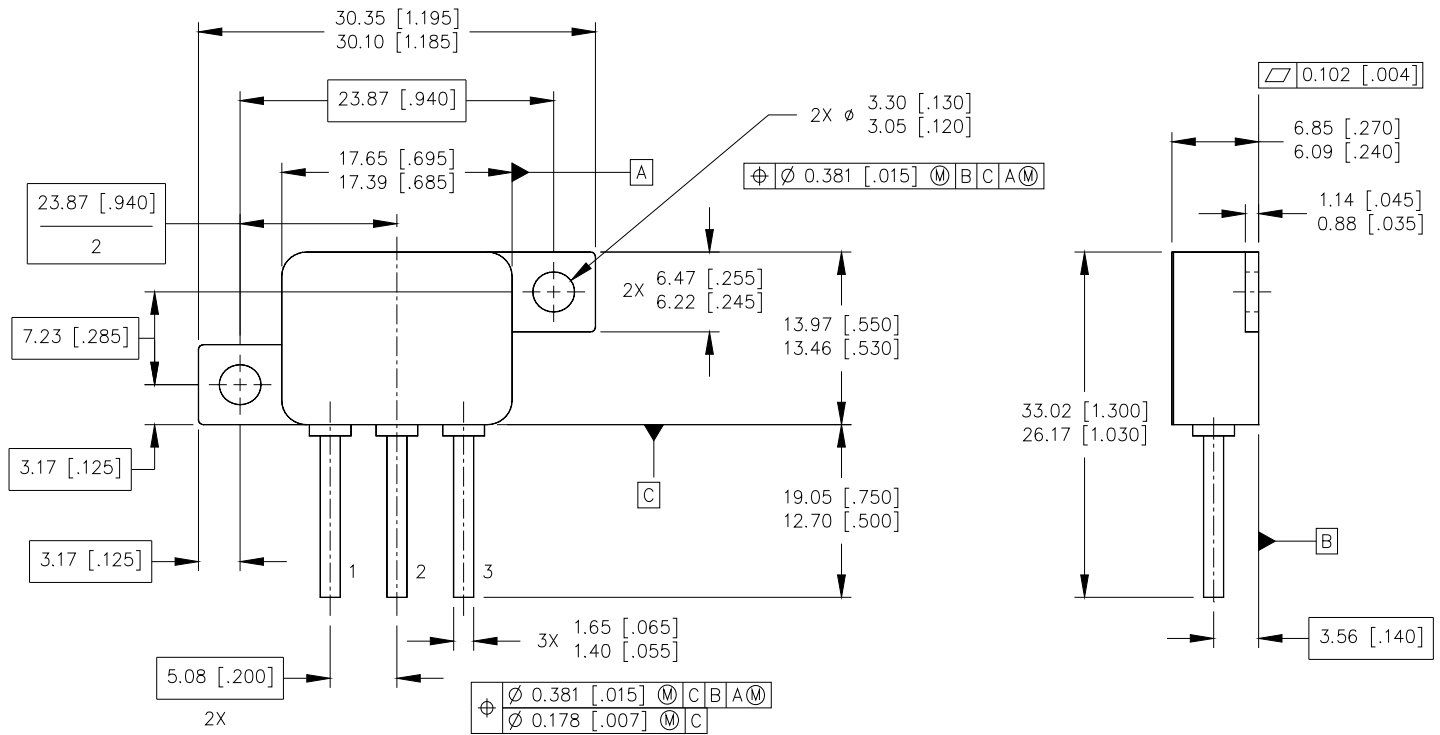
Fig. 9 Typical Reverse Recovery Parameter Test Circuit



- ① di_f/dt - Rate of change of current through zero crossing.
- ② I_{RRM} - Peak reverse recovery current.
- ③ t_{rr} - Reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75I_{RRM}$ and $0.5I_{RRM}$ extrapolated to zero current.
- ④ Q_{rr} - Area under curve defined by t_{rr} and I_{RRM} - $Q_{rr} = (t_{rr} \times I_{RRM}) / 2$
- ⑤ $di_{(rec)M}/dt$ - Peak rate of change of current during t_b position of t_{rr} .

Fig. 10 Reverse Recovery Waveform and Definitions

Case Outline and Dimensions — TO-259AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. CONTROLLING DIMENSION: INCH.
4. CONFORMS TO JEDEC OUTLINE TO-259AA.

PIN ASSIGNMENTS

Refer to page 1.

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